

# 林明澤

## 著作目錄

### 期刊論文

1. Yu Huang, Tra Anh Khoa Nguyen, Nhat Minh Dang, Hao-Yu Wang, and Ming-Tzer Lin\* (2024, Apr). Materials' properties of low temperature deposited Cu/W and Cu/Cr multilayer thin films using high power impulse magnetron sputtering. *Journal of Vacuum Science and Technology A: Vacuum, Surfaces and Films*, 42(3) May/Jun 2024; doi: 10.1116/6.0003512. (SCI, IF 2.9, Q2). nstc 110-2221-E-005-055-MY3. 本人為通訊作者.
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### 專書

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1. Lian-En Huang, Ching-Tse Chuang, Gu-Hao Xu, Ming-Tzer Lin\*, Terry Yuan-Fang Chen (2024, Jun). Using Digital Image Correlation Method for the Straightness Measurement of Component. 2024 SEM Annual Conference & Exposition on Experimental & Applied Mechanics, Washington, USA. nstc 110-2221-E-005-055-MY3. 本人為通訊作者.
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